COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled TAPE CIRCUIT SUBSTRATE HAVING WAVY BEAM LEADS AND SEMICONDUCTOR CHIP PACKAGE USING THE SAME, the specification of which:

\boxtimes	is attached hereto.	Application No.	
	was filed as A	(if applicable)	
\vdash	and was amended on	(if applicable).	
	with amendments through _	(II applicable).	
		erstand the contents of the aboard any amendment referred to ab	
I acknowledg of this application in	e the duty to disclose information accordance with Title 37, Co	ation which is material to the p de of Federal Regulations, Sec	atentability . 1.56.
(a)-(d) or §365(b) of of any PCT internation United States of Ame for patent or inventor	any foreign application(s) for onal application which design crica, listed below and have a	der Title 35, United States Cod patent or inventor's certificate ated at least one country other lso identified below any foreig international application having y is claimed:	e, or §365(a) than the n application
Prior Foreign Applica	ation(s)		Claiming Priority?
2003-15179	Republic of Korea	11 March 2003	
(Number)	(Country)	(Day/Month/Year Filed)	
	n the benefit under Title 35, Uonal application listed below	Jnited States Code, Sec. 119(e) of any
Provisional Application No.		Filing Date	

I hereby claim the benefit under Title 35, United States Code, Sec. 120 or §365(c) of any PCT international application designating the United States of America listed below and,

I hereby claim the benefit under Title 35, United States Code, Sec. 120 or §365(c) of any PCT international application designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby appoint the following attorneys to prosecute the application, to file a corresponding international application, to prosecute and transact all business in the Patent and Trademark Office connected therewith:

Customer No.

20575

PATENT TRADEMARK OFFICE

Attorney Name	Registration No.
Elmer W. Galbi	19,761
Jerome S. Marger	26,480
Alexander C. Johnson, Jr.	29,396
Alan T. McCollom	28,881
James G. Stewart	32,496
Stephen S. Ford	35,139
Julie L. Reed	35,349
Scott A. Schaffer	38,610
Joseph S. Makuch	39,286
James E. Harris	40,013
Kevin S. Ross	42,116
Graciela G. Cowger	42,444
Ariel Rogson	43,054
Craig R. Rogers	43,888
Hillary Brooks	45,815
Clifford D. Weston	48,307
Todd J. Iverson	53,057

Direct all telephone calls to <u>Alan T. McCollom</u> at (503) 222-3613 and send all correspondence to:

MARGER JOHNSON & McCOLLOM, P.C. 1030 S.W. Morrison Street Portland, Oregon 97205

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the

United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	first inventor: Dae-Woo SON	
Inventor's signature:	SON MEWOO	$\frac{\sqrt{0 \in C \cdot 04, 2003}}{\text{(Date)}}$
Residence: Chung	gcheongnam-do, Republic of Korea	
Citizenship: Repub	olic of Korea	
Post Office address:	No. 101-1608 Halla Dongbaek Apt., Sinbang-dong, Cheonan-City Chungcheongnam-do, Republic of Korea	
Full name of second	joint inventor: Jin-Hyuk LEE	
Inventor's signature:	1 Jimhyuk Lee	(Date)
Residence: Seoul,	Republic of Korea	
Citizenship: Repub	olic of Korea	
Post Office address:	No. 102, 48-53 Daejo-dong, Eunpyeong-ku, Seoul, Republic of Korea	
	nt inventor: Kwan-Jai LEE	
Inventor's signature!	Kwanyaë Lee	(Date)
Residence: Chung	cheongnam-do, Republic of Korea	
Citizenship: Repub	lic of Korea	
Post Office address:	No. 108-1706 Halla Dongback Apt., 909 Sinbang-dong, Cheonan-city Chungcheongnam-do, Republic of Korea	